

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT5775120

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YI-CHUNG CHEN	09/20/2019
CHENG-JEN LAI	09/20/2019
RECEIVING PARTY DATA	
Name:	WINBOND ELECTRONICS CORP.
Street Address:	NO. 8 KEYA 1ST RD., DAYA DISTRICT, CENTRAL TAIWAN SCIENCE PARK,
City:	TAICHUNG CITY
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16590673
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	0941/3698PUS1
NAME OF SUBMITTER:	JOE MCKINNEY MUNCY
SIGNATURE:	/Joe McKinney Muncy/
DATE SIGNED:	10/17/2019
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, Yi-Chung CHEN and Cheng-Jen LAI
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD FOR MANUFACTURING NON-VOLATILE MEMORY DEVICE

Filed: _____ Serial No. _____

Executed on: _____

WHEREAS, Winbond Electronics Corp. of No. 8 Keya 1st Rd.,
Daya District, Central Taiwan Science Park, Taichung City,
Taiwan, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring
ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent
which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for
good and valuable consideration, receipt of which is hereby acknowledged by Assignor,
Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign
and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their
rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on
the same in the United States, the said interest to be held and enjoyed by said Assignee as
fully and exclusively as it would have been held and enjoyed by said Assignor had this
Assignment and transfer not been made, to the full end and term of any Letters Patent which
may be granted thereon, or of any division, renewal, continuation in whole or in part,
substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said
Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments
of assignment and transfer thereof, and will perform such other acts as Assignee lawfully
may request, to obtain or maintain Letters Patent for said invention and improvement, and to
vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the
date(s) indicated.

Yi-Chung Chen
Yi-Chung CHEN

September 20, 2019
Date

Cheng-Jen LAI
Cheng-Jen LAI

September 20, 2019
Date